

50 V, 300 W, 150 MHz RF Power MOSFET

Product Overview

The VRF2933(MP) is a gold-metallized silicon n-channel RF power transistor designed for broadband commercial and military applications requiring high power and gain without compromising reliability, ruggedness, or intermodulation distortion. Adding MP at the end of part number specifies a matched pair where $V_{GS(TH)}$ is matched between the two parts.



Features

- Improved ruggedness V_{(BR)DSS} = 170 V
- 300 W with 22 dB typical gain at 30 MHz, 50 V
- · Excellent stability and low IMD
- Common source configuration
- Available in matched pairs (VRF2933MP)
- 70:1 load VSWR capability at specified operating conditions
- Nitride passivated
- · Refractory gold metallization
- · High voltage replacement for SD2933
- · Thermally enhanced package
- RoHS compliant

1. Device Specifications

This section shows the specifications of the VRF2933(MP) device.

1.1 Absolute Maximum Ratings

The following table shows the absolute maximum ratings of the VRF2933(MP) device. T_C = 25 $^{\circ}$ C unless otherwise specified.

Symbol	Parameter	Ratings	Unit
V _{DSS}	Drain source voltage	170	V
I _D	Continuous drain current	42	А
V _{GS}	Gate-source voltage	±40	V
P _D	Total power dissipation	648	W
T _{STG}	Storage temperature range	–65 to 150	°C
TJ	Operating junction temperature	200	

Table 1-1. Absolute Maximum Ratings

1.2 Electrical Performance

The following table shows the static characteristics of the VRF2933(MP) device. T_C = 25 $^{\circ}$ C unless otherwise specified.

Table 1-2. Static Characteristics

Symbol	Characteristic	Test Conditions	Min	Тур	Max	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	V _{GS} = 0 V, I _D = 100 mA	170	180		V
V _{DS(ON)}	On-state drain voltage	$I_{D(ON)}$ = 20 A, V_{GS} = 10 V		2.1	2.4	-
I _{DSS}	Zero gate voltage drain current	V_{DS} = 100 V, V_{GS} = 0 V			2.0	mA
I _{GSS}	Gate-source leakage current	V_{DS} = ±20 V, V_{DS} = 0 V			2.0	μA
g _{fs}	Forward transconductance	V_{DS} = 10 V, I _D = 20 A	8			mhos
V _{GS(th)}	Gate-source threshold voltage	V _{DS} = 10 V, I _D = 100 mA	2.9	3.6	4.4	V

The following table shows the thermal characteristics of the VRF2933(MP) device.

Table 1-3. Thermal Characteristics

Symbol	Characteristic	Min	Тур	Мах	Unit
R _{θJC}	Junction-to-case thermal resistance			0.27	°C/W

Note: These devices are sensitive to electrostatic discharge. Proper handling procedures should be followed.

The following table shows the dynamic characteristics of the VRF2933(MP) device. $T_C = 25$ °C unless otherwise specified.

Table 1-4. Dynamic Characteristics

Symbol	Characteristic	Test Conditions	Min	Тур	Max	Unit
C _{iss}	Input capacitance	V_{GS} = 0 V, V_{DS} = 50 V, f = 1 MHz		740		pF
C _{oss}	Output capacitance			400		
C _{rss}	Reverse transfer capacitance			32		

The following table shows the functional characteristics of the VRF2933(MP) device. $T_C = 25$ °C unless otherwise specified.

Table 1-5. Functional Characteristics

Parameter	Characteristics	Test Conditions	Min	Тур	Max	Unit
G _{PS}	Common source amplifier power gain	$f_1 = 30 \text{ MHz}, V_{DD} = 50 \text{ V}, I_{DQ} = 250 \text{ mA}, P_{out} = 300 \text{ W}$	20	25		dB
η	Drain efficiency	$ f_1 = 30 \; \text{MHz}, \; \text{V}_{\text{DD}} = 50 \; \text{V}, \; \text{I}_{\text{DQ}} = 250 \\ m\text{A}, \; \text{P}_{\text{out}} = 300 \; \text{W} \; \text{CW} $		50		%
Ψ	Electrical ruggedness VSWR 5:1	$ f_1 = 30 \text{ MHz}, \text{V}_{\text{DD}} = 50 \text{ V}, \text{I}_{\text{DQ}} = 250 \\ m\text{A}, \text{P}_{\text{out}} = 300 \text{ W CW} \\ 70:1 \text{ VSWR} - \text{ all phase angles,} \\ 0.2 \text{ ms} \times 20\% \text{ duty factor} $	No degra	adation in o	utput powe	er

1.3 Typical Performance Curves

This section shows the typical performance curves of the VRF2933(MP) device.



Device Specifications



Device Specifications



The following table shows the typical Class AB large signal input-output impedance for the VRF2933(MP) device.

Table 1-6	Typical	Class AB	Large Signal	Input-Output	Impedance
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Frequency (MHz)	Z _{in}	Z _{out}
2	23.6 - j 5.5	4.0 - j 0.1
13.5	7.6 - j 10.1	3.9 - j 0.6
27.1	3.5 - j 6.0	3.7 - j 1.1
40.7	2.5 - j 4.0	3.3 - j 1.5
65	1.95 - j 2.07	2.6 - j 1.9
100	1.8 - j 0.66	1.76 - j 0.2
150	1.78 + j 0.5	1.03 + j 1.7

Notes:

- * Z_{in} Gate shunted with 25 Ω
- I_{dq} = 250 mA
- Z_{OL} Conjugate of optimum load for 300 W output at V_{dd} = 50 V
- j = √ 1

VRF2933, VRF2933MP Test Circuits

2. Test Circuits

The following figure shows the test circuit of the VRF2933 device.





C1 1800pF ATC100B ceramic C2, C3, C5, C9, C10, C12 0.1uF 100V C6 680 pF metal clad 500V mica C7 ARCO 467 mica trimmer C8 100 pF ATC 100E ceramic C4, C11 10uF 100V Electrolytic FB small ferrite bead $u_i = 125$ L1 20 nH 2t #18 0.188"d .2"I L2 38 nH - 2.5t #14 enam. .25" dia. L3 2t #16 on 2x 267300081 .5" bead R1-R2 1k Ohm 1/4W R3 100 Ohm 1W R4 470 Ohm "low inductance" 3W T1 16:1 transformer 4t #20 teflon on RF Parts Co. T1/2 transformer core T2 9:1 transformer 3t #16 teflon on RF Parts Co. T1 transformer core

3. Package Specification

This section shows the package specification of the VRF2933(MP) device.

3.1 Package Outline Drawing

The following figure illustrates the package outline of the VRF2933(MP) device.

Figure 3-1. M177 Package Outline



Note: Hazardous Material Warning!

The ceramic portion of the device between leads and mounting flange is beryllium oxide. Beryllium oxide dust is highly toxic when inhaled. Care must be take during handling and mounting to avoid damage to this area. These devices must never be thrown away with general industrial or domestic waste.

The following table shows the package dimensions for the VRF2933(MP) device.

Table 3-1. Package Dimensions

Dimension	Min.	Тур.	Max.
A	0.225	0.230	0.235

Package Specification

continued					
Dimension	Min.	Тур.	Max.		
В	0.265	0.270	0.275		
С	0.860	0.865	0.870		
D	1.130	1.135	1.140		
E	0.545	0.550	0.555		
F	0.003	0.005	0.007		
G	0.098	0.103	0.108		
Н	0.150	0.160	0.170		
I			0.280		
J	1.080	1.100	1.120		
К	0.625	0.630	0.635		

4. Matched Pair Part Marking

Adding MP at the end of part number specifies a matched pair where $V_{GS(TH)}$ is matched between the two parts. V_{TH} range codes are marked on the devices per the following table.

Code	V _{TH} Range	Code	V _{TH} Range
A	2.900–2.975	Μ	3.650–3.725
В	2.975–3.050	Ν	3.725–3.800
С	3.050–3.125	Р	3.800–3.875
D	3.125–3.200	R	3.875–3.950
E	3.200–3.275	S	3.950-4.025
F	3.275–3.350	Т	4.025–4.100
G	3.350-3.425	W	4.100–4.175
Н	3.425–3.500	Х	4.175–4.250
J	3.500–3.575	Y	4.250-4.325
К	3.575–3.650	Z	4.325-4.400

Table 4-1. V_{TH} Range Codes

Note: V_{TH} values are based on Microchip measurements at datasheet conditions with an accuracy of 1.0%.

5. Revision History

Table 5-1. Revision History

Revision	Date	Description
A	02/2022	 Document migrated from Microsemi template to Microchip template; Assigned Microchip literature number DS-00004434A,which replaces the previous Microsemi literature number 050-4941. Reduced V_{DS(on)} limit from 2.7 V max. to 2.4 V max.
Initial releases (Microsemi Revisions A through K)	12/2006 – 10/2020	Previous releases.

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